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U.S. DEPARTMENT OF COMMERCE

U.S. Patent and Trademark Office

401510-0007 CIP

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Shafidul Islam

Romarico Santos San Antonio

7-18-03

2. Name and address of receiving party(ies)

Name: Advanced Interconnect Technologies Limited

Internal Address: _____

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:



Assignment



Merger



Security Agreement



Change of Name



Other _____

Street Address: Batamindo Industrial Park

Muka Kuning, Batam Island 29433, Indonesia

City: _____ State: _____ Zip: _____

Execution Date: 06/20/2003

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s) 10/342,732

B. Patent No.(s) _____

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: White & Case LLP

Internal Address: _____

Street Address: Patent Department

1155 Avenue of the Americas

City: New York State: NY Zip: 10036

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$ 40.00



Enclosed



Authorized to be charged to deposit account

8. Deposit account number:

23-1703

07/24/2003

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9. Signature.

40.00 OP

John M. Genova, Reg. No. 32,224

Name of Person Signing

Signature

July 15, 2003

Date

Total number of pages including cover sheet, attachments, and documents: 5

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231PATENT
REEL: 014303 FRAME: 0621

ASSIGNMENT

WHEREAS, we, Shafidul Islam and Romarico Santos San Antonio, (the "Inventors"), citizens of the United States of America and the Philippines, respectively, and residing respectively at 3829 Lakedale Drive, Plano, Texas 75025; and Taman Duta Mas, Block A 03-9, Batam Center, Batam Island, Indonesia 29433, have made an invention entitled **PARTIALLY PATTERNED LEAD FRAMES AND METHODS OF MAKING AND USING THE SAME IN SEMICONDUCTOR PACKAGING** for which we made an application for Letters Patent of the United States, and which U.S. application was filed on January 15, 2003 and assigned Serial No. 10/342,732; and

WHEREAS, **ADVANCED INTERCONNECT TECHNOLOGIES LIMITED** (the "Assignee"), a company organized and existing under the laws of Mauritius, and having an office for the transaction of business at: Batamindo Industrial Park, Muka Kuning, Batam Island 29433, is desirous of acquiring the entire right, title and interest in and to said invention and any improvements thereon, and in and to the said application for Letters Patent therefor, and any Letters Patent which may be obtained therefor;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, BE IT KNOWN, that we the said Inventors for and in consideration of the sum of One Dollar (\$1.00), lawful money of the United States, to us in hand paid by said Assignee, and other valuable considerations unto us moving from said Assignee, at or before the ensealing and delivery of these presents, the receipt of which is hereby acknowledged, have sold, assigned, transferred and conveyed and by these presents do sell, assign, transfer and convey, unto said Assignee, its successors and assigns, the entire right, title and interest in and to the said invention as set forth and described in the specification forming a part of the application for Letters Patent of the United States for **PARTIALLY PATTERNED LEAD FRAMES AND METHODS OF MAKING AND USING THE SAME IN SEMICONDUCTOR PACKAGING**, and any and all improvements thereon, and in and to said application and any division, continuation or continuation-in-part thereof, and in and to any Letters Patent of the United States which may be issued on any of said applications, and any reissues thereof, and in and to any and all applications for Letters Patent filed in foreign countries for said invention or improvements, including all priority rights, and any and all Letters Patent which may be granted in foreign countries therefor, TO HAVE AND TO HOLD THE SAME to the full end of the term or terms for which any and all said Letters Patent may be granted;

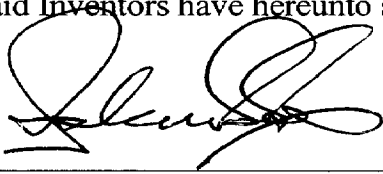
AND we the said Inventors, do hereby authorize and request the Commissioner of Patents and Trademarks to issue the said Letters Patent of the United States to said Assignee, as the assignee of the entire right, title and interest in and to the same, for the sole use and behoof of said Assignee, its successors and assigns;

AND we the said Inventors, for the considerations aforesaid, do hereby covenant and agree to and with said Assignee, its successors and assigns, that we have the full power to make this assignment, and that the rights assigned are not encumbered by any grant, license or right heretofore given, and that we, our executors or administrators, shall and will do all lawful acts and things and make, execute and deliver without further compensation, any and all other instruments in writing, further applications, papers, affidavits, powers of attorney, assignments, and other

documents which, in the opinion of counsel for said Assignee, its successors and assigns, may be required or necessary to more effectively secure to and vest in said Assignee, its successors and assigns, the entire right, title and interest in and to said invention and improvements, applications, Letters Patent, rights, benefits, privileges and advantages hereby sold, assigned, transferred and conveyed, and that we will sign any applications for reissue which may be desired by the owner of the patent or patents which may be issued for the said invention or improvements.

IN WITNESS WHEREOF, we, the said Inventors have hereunto set my hand and seal on the date below written.

Date: June 20, 2003


Shafidul Islam

WITNESS:

Signature: 

Name: Tan See Han
Address: 53 Greenmead Avenue
Singapore 289444

WITNESS:

Signature: 

Name: MICHAEL D. MCKENNA
Address: 3028 RANDY LANE
FARMERS BRANCH, TEXAS 75234

Date: 20 June, 2003


Romarico Santos San Antonio

WITNESS:

Signature: 

Name: Tan See Han
Address: 53 Greenmead Avenue
Singapore 289444

WITNESS:

Signature: 

Name: MICHAEL H. MCKENNA
Address: 3028 RANDY LANE
FARMERS BRANCH, TEXAS 75234